PCB DESIGN AND ANALYSIS

TECHNOLOGIES:

- Digital high speed (DDR4, SERDES, USB3, etc)
- Power BOARD (OVER 100Amp_base copper 6oz), switching module
- Mixed Technologies, ANALOG BOARD

PCB design, production and assembly in according to standard IPC
PCB PRODUCTION

16 layer mixed material ENEPIG

Aluminium trace over FR4

COPPER HEATSINK

Rigid-flex polyimide base material
PRODUCTION & ASSEMBLY

Module assembly

PCB assembly

Bonding

PCB assembly